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**REQUEST
FOR**

**CONTINUED EXAMINATION (RCE)
TRANSMITTAL**

Subsection (b) of 35 U.S.C. § 132, effective on May 29, 2000, provides for continued examination of an utility or plant application filed on or after June 8, 1995.
See The American Inventors Protection Act of 1999 (AIPA).

Application Number

09/255,777

Filing Date

February 23, 1999

First Named Inventor

Shunpei YAMAZAKI et al.

Group Art Unit

2812

Examiner Name

R. Booth

Attorney Docket Number

740756-1936

This is a Request for Continued Examination (RCE) under 37 C.F.R. § 1.114 of the above-identified application.

NOTE: 37 C.F.R. § 1.114 is effective on May 29, 2000. If the above-identified application was filed prior to May 29, 2000, applicant may wish to consider filing a continued prosecution application (CPA) under 37 C.F.R. § 1.53(d) (PTO/SB/29) instead of a RCE to be eligible for the patent term adjustment provisions of the AIPA. See Changes to Application Examination and Provisional Application Practice, Final Rule, 65 Fed. Reg. 50092 (Aug. 16, 2000); Interim Rule, 65 Fed. Reg. 14865 (Mar. 20, 2000), 1233 Off. Gaz. Pat. Office 47 (Apr. 11, 2000), which established RCE practice.

1. Submission required under 37 C.F.R. § 1.114

- a. Previously submitted
 - i. Consider the amendment(s)/reply under 37 C.F.R. § 1.116 previously filed on _____
(Any unentered amendment(s) referred to above will be entered).
 - ii. Consider the arguments in the Appeal Brief or Reply Brief previously filed on _____
 - iii. Other _____
- b. Enclosed
 - i. Amendment/Reply
 - ii. Affidavit(s)/Declaration(s)
 - iii. Information Disclosure Statement (IDS)
 - iv. Other Petition for Extension of Time – (One Month)

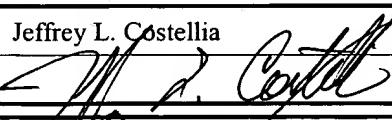
2. Miscellaneous

- a. Suspension of action on the above-identified application is requested under 37 C.F.R. § 1.103(c) for a period of _____ months. (Period of suspension shall not exceed 3 months; Fee under 37 C.F.R. § 1.17(l) required)
- b. Other _____

3. Fees The RCE fee under 37 C.F.R. § 1.17(e) is required by 37 C.F.R. § 1.114 when the RCE is filed.

- a. The Director is hereby authorized to charge the following fees, or credit any overpayments, to Deposit Account No. 19-2380
 - i. RCE fee required under 37 C.F.R. § 1.17(e)
 - ii. Extension of time fee (37 C.F.R. §§ 1.136 and 1.17)
 - iii. Other _____
- b. Check in the amount of \$ 850.00 enclosed
- c. Payment by credit card (Form PTO-2038 enclosed)

SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT REQUIRED

Name (Print/Type)	Jeffrey L. Costellia	Registration No. (Attorney/Agent)	35,483
Signature		Date	11/27/01

CERTIFICATE OF MAILING OR TRANSMISSION

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner For Patents, Box RCE, Washington, DC 20231, or facsimile transmitted to the U.S. Patent and Trademark Office on:

Name (Print/Type)			
Signature		Date	

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Docket No. 740756-1936

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of)

Shunpei YAMAZAKI et al.)

Application Serial No. 09/255,777)

Filed: February 23, 1999)

For: SEMICONDUCTOR DEVICE AND METHOD FOR)
FORMING THE SAME)

Art Unit: 2812

Examiner: R. Booth

#25/F
12/21/01
J. Varnell
C. Booth
R. Booth

AMENDMENT

Commissioner for Patents
Washington, D.C. 20231
Sir:

Responsive to the Office Action dated **August 21, 2001**, the period for response having been extended one (1) month to December 21, 2001, the following amendments and remarks are submitted in connection with the above-identified application.

IN THE CLAIMS:

Please cancel claims 14, 59 and 72-74 without prejudice or disclaimer to the subject matter recited therein.

Please amend claims 12, 18, 23, 29, 34, 37, 41, 53, 55 and 58 as follows. Attached hereto is a marked-up copy of the amended claims.

12. (Amended) A method for fabricating a semiconductor device,

comprising the steps of:

forming a semiconductor film comprising amorphous silicon on an insulating surface;

forming an insulating film on said semiconductor film;

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